# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Jay Hyuk Kim	11/29/2006

#### **RECEIVING PARTY DATA**

Name:	International Business Machines Corporation
Street Address:	New Orchard Road
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11565226

### **CORRESPONDENCE DATA**

Fax Number: (972)385-7766

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (972) 385-8777
Email: sfay@yeeiplaw.com

Correspondent Name: Duke W. Yee

Address Line 1: Yee & Associates, P.C.
Address Line 2: P.O. Box 802333
Address Line 4: Dallas, TEXAS 75380

ATTORNEY DOCKET NUMBER:	RPS920060115US1
NAME OF SUBMITTER:	Duke W. Yee

Total Attachments: 1

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PATENT REEL: 018568 FRAME: 0534

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IBM DOCKET NO. RPS920060115US1

#### ASSIGNMENT

Whereas, I,

(1) Jay Hyuk Kim County of Wake

of Raleigh and State of Texas

have invented certain improvements in

#### Multi-Roll Paper Supply for Printer

and executed, respectively, a United States patent application therefore on (Date Inventor Signed Declaration) (1) November 71th \_\_\_\_\_, 2006.

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

(1) Signed at RTP, NC on November 29th, 2006.

Jay Hyuk Kin